



Multi-Service Cloud-Based IoT Platforms

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Deadline for manuscript
submissions:

closed (31 August 2023)

Message from the Guest Editors

Dear Colleagues,

The aim of this Special Issue of *Electronics* is to present state-of-the-art R&D efforts in building multi-service cloud-based IoT platforms of horizontal type, applicable to different IoT domains. We invite scholars to contribute original and unique research articles, as well as review articles.

Topics of interest include, but are not limited to:

- Generic solutions for the development of IoT platforms
- Cost-efficient methods for building IoT platforms
- Horizontal-slice IoT platform solutions
- Multi-service oriented IoT platforms
- Cloud-based IoT platforms
- IoT platforms supporting heterogeneous-type communications
- IoT platforms supporting heterogeneous-type data exchange
- Flexible, scalable, and easily expandable IoT platforms
- Multi-purpose IoT platforms
- Easy adjustable IoT platforms to new use cases and scenarios
- Open-source IoT platforms
- IoT platforms with open APIs
- IoT platforms with open data
- IoT platforms with open layers
- (open) Standard-based IoT platforms





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Editor-in-Chief

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Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guest-edited by leading experts in selected topics of interest.

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